# 1. Part No. Expression

# SDC 0604100 M F

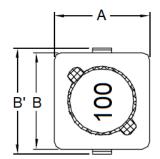
- (a)
- (b)
- (c) (d) (e)
- (a) Series Code

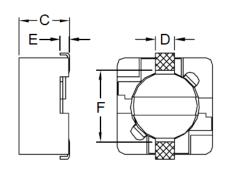
- (d) Tolerance Code
- (b) Dimension Code

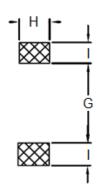
(e) Packaging Code

(c) Inductance Code

# 2. Configuration & Dimensions (Unit: mm)







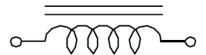
Recommended PCB Layout

Note: 1. The above PCB layout reference only.

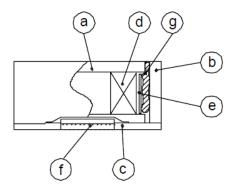
2. Marking: Inductance Code

| А       | В       | B'      | С       | D       |
|---------|---------|---------|---------|---------|
| 6.2±0.3 | 5.9±0.3 | 6.6±0.3 | 5.0 Max | 1.5 Ref |
| E       | F       | G       | Н       | I       |
| 0.6 Ref | 4.6 Ref | 4.6 Ref | 1.9 Ref | 1.4 Ref |

## 3. Schematic



## 4. Material List



- (a) Core
- (b) Core
- (c) Base
- (d) Wire
- (e) Tape
- (f) Terminal
- (g) Adhesive

## 5. General Specifications

- (a) Operating Temp.: -30°C to +105°C (including self-temperature rise)
- (b) All test data referenced to 25°C ambient.
- (c) Heat Rated Current (Irms) will cause the coil temperature rise ΔT of 40°C Max.
- (d) Saturation Current (Isat) will cause inductance L0 to drop 25% Max.
- (e) Rated Current: The lower value of Isat and Irms.
- (f) Resistance to solder heat: 260° C, 10 secs
- (g) Storage Condition (Component in its packaging)
  - i) Temperature: -10°C to 40°C
  - ii) Humidity: Less than 60% RH

# 6. Electrical Characteristics

| Part Number  | Inductance<br>(uH) @0A<br>±20% | Test<br>Frequency | DCR<br>(Ω)<br>Max | IDC<br>(A)<br>Max |
|--------------|--------------------------------|-------------------|-------------------|-------------------|
| SDC0604100MF | 10                             | 0.25V/1KHz        | 0.12              | 1.35              |
| SDC0604120MF | 12                             | 0.25V/1KHz        | 0.13              | 1.22              |
| SDC0604150MF | 15                             | 0.25V/1KHz        | 0.18              | 1.11              |
| SDC0604180MF | 18                             | 0.25V/1KHz        | 0.24              | 1.02              |
| SDC0604220MF | 22                             | 0.25V/1KHz        | 0.27              | 0.91              |
| SDC0604270MF | 27                             | 0.25V/1KHz        | 0.30              | 0.82              |
| SDC0604330MF | 33                             | 0.25V/1KHz        | 0.33              | 0.74              |
| SDC0604390MF | 39                             | 0.25V/1KHz        | 0.37              | 0.69              |
| SDC0604470MF | 47                             | 0.25V/1KHz        | 0.52              | 0.62              |
| SDC0604560MF | 56                             | 0.25V/1KHz        | 0.56              | 0.58              |
| SDC0604680MF | 68                             | 0.25V/1KHz        | 0.63              | 0.51              |
| SDC0604820MF | 82                             | 0.25V/1KHz        | 0.71              | 0.46              |
| SDC0604101MF | 100                            | 0.25V/1KHz        | 1.03              | 0.42              |
| SDC0604121MF | 120                            | 0.25V/1KHz        | 1.15              | 0.38              |
| SDC0604151MF | 150                            | 0.25V/1KHz        | 1.68              | 0.35              |
| SDC0604181MF | 180                            | 0.25V/1KHz        | 1.87              | 0.32              |
| SDC0604221MF | 220                            | 0.25V/1KHz        | 2.08              | 0.29              |
| SDC0604271MF | 270                            | 0.25V/1KHz        | 2.37              | 0.26              |
| SDC0604331MF | 330                            | 0.25V/1KHz        | 2.67              | 0.23              |
| SDC0604391MF | 390                            | 0.25V/1KHz        | 2.94              | 0.22              |
| SDC0604471MF | 470                            | 0.25V/1KHz        | 3.93              | 0.20              |
| SDC0604561MF | 560                            | 0.25V/1KHz        | 5.43              | 0.18              |
| SDC0604681MF | 680                            | 0.25V/1KHz        | 7.32              | 0.18              |
| SDC0604821MF | 820                            | 0.25V/1KHz        | 8.24              | 0.15              |
| SDC0604102MF | 1000                           | 0.25V/1KHz        | 9.26              | 0.14              |



## 7. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

### 7-1. IR Soldering Reflow

Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

### 7-2. Iron Reflow

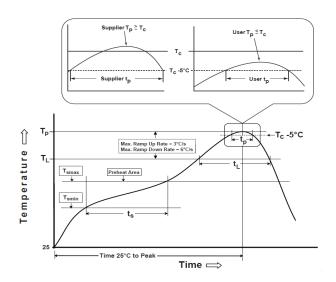
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

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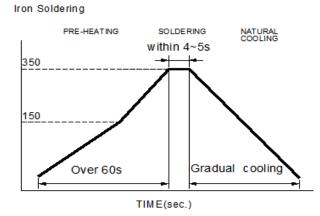
**TEM PERATURE**(

#### Note:

- (a) Preheat circuit and products to 150°C.
- (b) 355°C tip temperature (Max.)
- (c) Never contact the ceramic with the iron tip
- (d) 1.0mm tip diameter (Max.)
- (e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- (f) Limit soldering time to 4~5 sec.



Reflow times: 3 times Max
Figure 1: IR Soldering Reflow



Iron Soldering times: 1 times max.

Soldering iron method: 350±5°C Max

Figure 2: Iron soldering temperature profiles



Table (1.1) Reflow Profiles

| Profile Type:  | Pb-Free Assembly |
|--|------------------|
| Preheat  |                  |
| -Temperature Min (T <sub>smin</sub> )                                      | 150°C            |
| -Temperature Max (T <sub>smax</sub> )                                      | 200°C            |
| -Time $(t_s)$ from $(T_{smin}$ to $T_{smax})$                              | 60-120seconds    |
| Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )                           | 3°C /second max. |
| Liquids temperature (T <sub>L</sub> )                                      | 217°C            |
| Time (t <sub>L</sub> ) maintained above T <sub>L</sub>                     | 60-150 seconds   |
| Classification temperature (Tc)  | See Table (1.2)  |
| Time (t <sub>p</sub> ) at Tc- 5°C (Tp should be equal to or less than Tc.) | *< 30 seconds    |
| Ramp-down rate $(T_p \text{ to } T_L)$                                     | 6°C /second max. |
| Time 25°C to peak temperature  | 8 minutes max.   |

**Tp**: maximum peak package body temperature, **Tc**: the classification temperature.

For user (customer) **Tp** should be equal to or less than **Tc**.

Table (1.2) Package Thickness/Volume and Classification Temperature (T<sub>c</sub>)

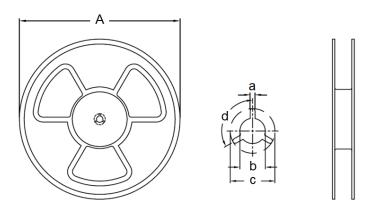
|          | Package   | Volume mm <sup>3</sup> | Volume mm <sup>3</sup> | Volume    |
|----------|-----------|------------------------|------------------------|-----------|
|          | Thickness | <350                   | 350-2000               | mm³ >2000 |
| PB-Free  | <1.6mm    | 260°C                  | 260°C                  | 260°C     |
|          | 1.6-2.5mm | 260°C                  | 250°C                  | 245°C     |
| Assembly | ≥2.5mm    | 250°C                  | 245°C                  | 245°C     |

Reflow is referred to standard IPC/JEDEC J-STD-020E.

<sup>\*</sup>Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

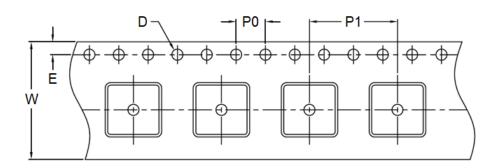
# 8. Packaging Information

## 8-1. Reel Dimension (Unit: mm)

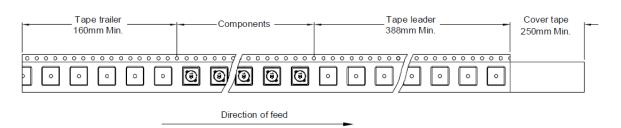


| Туре     | Α     | а       | b        | С        | d    |
|----------|-------|---------|----------|----------|------|
| 13"x16mm | 330.0 | 2.5 Ref | 13.0 Ref | 23.0 Ref | 120° |

## 8-2. Tape Dimension (Unit: mm)



| W         | E         | D               | P0        | P1        |
|-----------|-----------|-----------------|-----------|-----------|
| 16.00 Ref | 1.75±0.10 | 1.50+0.10/-0.00 | 4.00±0.10 | 12.00 Ref |

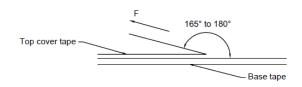




## 8-3. Packaging Quantity (Unit: Pcs)

| INNER : REEL |         | OUTER : CARTON |         |          |
|--------------|---------|----------------|---------|----------|
| QTY(PCS)     | G.W(gw) | QTY(PCS)       | G.W(Kg) | SIZE(cm) |
| 1,000        | 0.85    | 16,000         | 18      | 36x36x40 |

## 8-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

| Room<br>Temp.<br>(°C) | Room<br>Humidity<br>(%) | Room atm<br>(hPa) | Tearing<br>Speed<br>(mm/min) |
|-----------------------|-------------------------|-------------------|------------------------------|
| 5~35                  | 45~85                   | 860~1060          | 300±10                       |

| Tape Size                       | 8 mm   | 12 to 56 mm | 72 mm or Wider |
|---------------------------------|--------|-------------|----------------|
| Tearing Off<br>Force<br>(grams) | 10~100 | 10~130      | 10~150         |

# **Application Notice**

### 1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

#### 2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

